

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tae KIM IL	06/18/2007
Sang Yoon LEE	06/18/2007
Kang Eui CHO	06/18/2007
Jung Joo YOO	06/18/2007
In Hyeuk CHOI	06/18/2007
Jae Won JEONG	06/18/2007
Seon Kyu KIM	06/18/2007
Tae Hyun SUNG	06/18/2007

RECEIVING PARTY DATA

Name:	LG Electronics Inc.
Street Address:	20, Yeouido-dong, Yeongdeungpo-gu
City:	Seoul
State/Country:	KOREA, REPUBLIC OF
Postal Code:	150-721

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29282030

CORRESPONDENCE DATA

Fax Number: (703)205-8050

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 7032058000

Email: parkb@bskb.com

Correspondent Name: Birch, Stewart, Kolasch & Birch, LLP

Address Line 1: P.O. Box 747

Address Line 4: Falls Church, VIRGINIA 22040-0747

CH \$40.00 29282030

500314158

PATENT
REEL: 019556 FRAME: 0024

ATTORNEY DOCKET NUMBER:	0465-1818PUS1
NAME OF SUBMITTER:	James T. Eller. Jr.
Total Attachments: 2 source=20070711ASSIGNMENT#page1.tif source=20070711ASSIGNMENT#page2.tif	

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application No. 29/282,030

Filed July 10, 2007

Insert Name(s)
of Inventor(s)

WHEREAS, KIM, Tae Il / LEE, Sang Yoon / CHO, Kang Eui / YOO, Jung Joo /

CHOI, In Hyeuk / JEONG, Jae Won / KIM, Seon Kyu / SUNG, Tae Hyun

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in

Insert Title
of Invention

Decorative film for home appliances

for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application).

Insert Date
of Signing of
Application

on June 18, 2007; and

Insert Name
of Assignee

WHEREAS, LG Electronics Inc.

Insert Address
of Assignee

of 20, Yeouido-dong, Yeongdeungpo-gu, Seoul, Korea 150-721

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

CHECK BOX
IF APPROPRIATE

☐ in any foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorizes(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date <u>June 18, 2007</u>	Name of Inventor <u>Kim, Tae Il</u> (signature) KIM, Tae Il
Date <u>June 18, 2007</u>	Name of Inventor <u>Lee, Sang Yoon</u> (signature) LEE, Sang Yoon
Date <u>June 18, 2007</u>	Name of Inventor <u>Cho, Kang Eui</u> (signature) CHO, Kang Eui
Date <u>June 18, 2007</u>	Name of Inventor <u>Yoo, Jung Joo</u> (signature) YOO, Jung Joo
Date <u>June 18, 2007</u>	Name of Inventor <u>Choi, In Hyeuk</u> (signature) CHOI, In Hyeuk
Date <u>June 18, 2007</u>	Name of Inventor <u>Jeong, Jae Won</u> (signature) JEONG, Jae Won
Date <u>June 18, 2007</u>	Name of Inventor <u>Kim, Seon Kyu</u> (signature) KIM, Seon Kyu
Date <u>June 18, 2007</u>	Name of Inventor <u>Sung, Tae Hyun</u> (signature) SUNG, Tae Hyun